

(1.27 mm) .050"

SEAM SERIES

HIGH-SPEED/HIGH-DENSITY OPEN-PIN-FIELD

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SEAM

Insulator Material:

Black LCP

Contact Material:

Copper Alloy

Operating Temp Range:

-55 °C to +125 °C

Current Rating (7 mm stack height):

2.7 A per pin
(10 adjacent pins powered)

Plating:

Au or Sn over

50 μ" (1.27 μm) Ni

Working Voltage:

240 VAC

RoHS Compliant:

Yes (-2 Solder type only)

Lead-Free Solderable:

Yes

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



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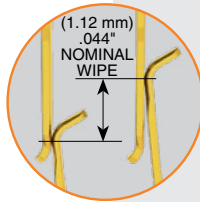
STANDARDS

- VITA 47
- VITA 57.1 FMC
- VITA 57.4 FMC+
- VITA 74 VNX
- PISMO™ 2

Visit www.samtec.com/standards for more information.

Mates with:
SEAF, SEAFP

Standoffs:
JSO



Low
insertion/
extraction
forces

Up to 500
Pins



Solder
charges

HIGH-SPEED CHANNEL PERFORMANCE

SEAF/SEAM @ 10 mm Mated Stack Height

Rating based on Samtec reference channel.
For full SI performance data visit Samtec.com
or contact SIG@samtec.com

PAM 4

56
Gbps

OTHER SOLUTIONS

- Up to 560 pins

SEAM

NO. PINS
PER ROWLEAD
STYLEPLATING
OPTIONNO. OF
ROWSSOLDER
TYPE

A

K

"X"R

**-10, -15, -20,
-30, -40, -50**
(-10 only available
in 04 row)
(-15 is only available
in 4 Row with -02.0
lead style and 10 row
with any lead style)

Specify
LEAD
STYLE
from
chart

-L
= 10 μ" (0.25 μm)
Gold on
contact area,
Matte Tin on
solder tail

-S
= 30 μ" (0.76 μm)
Gold on
contact area,
Matte Tin on
solder tail

-04
=Four Rows
(-06.5 not
available)

-05
=Five Rows
(-06.5 not
available)

-06
=Six Rows
(-06.5 not
available)

-08
=Eight Rows

-10
=Ten Rows

-1
= Tin/Lead
Alloy
Solder
Charge

-2
= Lead-Free
Solder
Charge

-A
= Alignment Pins
(Required. Arrays
will not self-center
on solder pads)

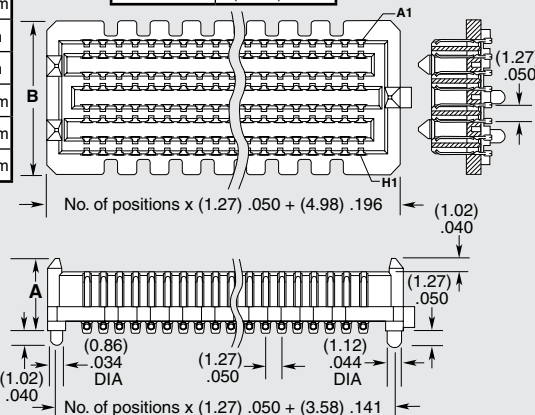
-K
= Polyimide film
Pick & Place Pad

-TR
=Tape & Reel

-FR
= Full Reel Tape &
Reel Packaging
(Must order max. quantities
per reel. Contact Samtec
for parts per reel)

SEAM LEAD STYLE	MATED HEIGHTS SEAF LEAD STYLE			
	-05.0	-06.0	-06.5	-07.5
-02.0	7 mm	8 mm	8.5 mm	9.5 mm
-03.0	8 mm	9 mm	9.5 mm	10.5 mm
-03.5	8.5 mm	9.5 mm	10 mm	11 mm
-06.5	11.5 mm	12.5 mm	13 mm	14 mm
-07.0	12 mm	13 mm	13.5 mm	14.5 mm
-09.0	14 mm	15 mm	15.5 mm	16.5 mm
-11.0	16 mm	17 mm	17.5 mm	18.5 mm

NO. OF ROWS	B
-04	(7.06) .278
-05, -06	(9.60) .378
-08	(12.14) .478
-10	(14.68) .578



LEAD STYLE	A
-02.0	(5.61) .221
-03.0	(6.60) .260
-03.5	(7.11) .280
-06.5	(10.16) .400
-07.0	(10.59) .417
-09.0	(12.60) .496
-11.0	(14.61) .575

POWER/SIGNAL APPLICATION



Compatible with
UMPT/UMPS for flexible
two-piece power/signal solutions

Notes:

IPC-A-610F & IPC-J-STD-001F
Class 3 solder joint.

Some sizes, styles and
options are non-standard,
non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.